

IN THE CLAIMS:

Please amend the claims as follows:

1. (Currently amended) A multilaser device used in an image forming apparatus to form an electrostatic image on a photosensitive member, said multilaser device comprising:

a first laser chip produced from a wafer lot;

a second laser chip produced from the same wafer lot as that of the first laser chip, a layer structure of said second laser chip being the same as a layer structure of said first laser chip;

a common back beam sensor for receiving a first back beam and a second back beam emitted from said first laser chip ~~[[chop]]~~ and said second laser chip, respectively; and

a package containing said first laser chip, said second laser chip and said back beam sensor.

2. (Original) A multilaser device according to Claim 1, wherein a difference  $\lambda$  between oscillation wavelengths of said first laser chip and said second laser chip is  $\lambda \leq 1.5$  nm.

3. (Original) A multilaser device according to Claim 1, wherein positional accuracy  $\Delta Z$  of light emitting points of said first laser chip and said second laser chip is  $\Delta Z \leq 5 \mu\text{m}$ .

4. (Canceled)